



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Kouichi IKEDA et al

Art Unit: 2823

S. N. 09/716,843

Examiner: B. Kebede

Filed: November 17, 2000

For: SEMICONDUCTOR DEVICE AND  
METHOD FOR MANUFACTURING  
THE SAME

RECEIVED  
APR 14 2003  
TECHNOLOGY CENTER 2800

#9/A  
Amend #9  
Y. Robinson  
4/24/03

R E S P O N S E

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In response to the Office Action dated October 4, 2002, for which a 3 month extension of time is requested, to extend the period for response to April 4, 2003, please amend the above-identified application as follows:

In the claims:

Please cancel non-elected claims 1-4, 7 and 10.

Please amend claims 5 and 8 by replacing it with the like-numbered claim hereinbelow. Markups are provided at the end of this response showing the changes made by the amendment.

al 5. (Amended) A method for manufacturing the semiconductor device, comprising:

a first step of forming a plurality of identical semiconductor chips on a semiconductor wafer;